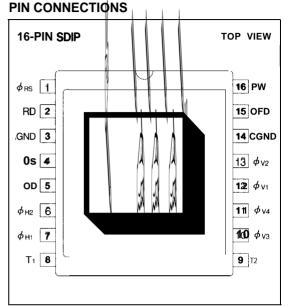
# LZ2314J

## DESCRIPTION

U2314J is a 1/3-type (6.0 mm) solid-state image sensor that consists of PN phote-diodes and CCDS (charge-coupled devices). Having approximately 270000 pixels (horizontal 542 x vertical 492), the sensor provides a high resolution stable B/W image,

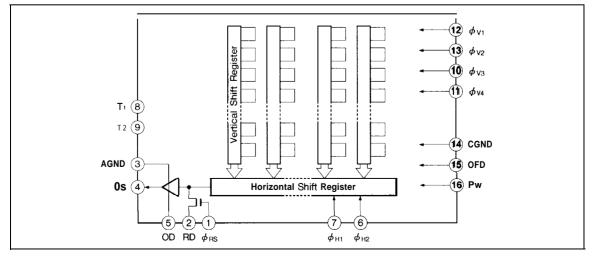
## FEATURES

- Number of pixels : 512 (H) x 492 (V) Pixel pitch : 9.6 μm(H)×7.5 μm (V) Number of optical black pixels : Horizontal; front 2 and rear 28
- Low fixed pattern noise and lag
- No sticking and no image distortion
- Blooming suppression structure
- Built-in output amplifier
- Variable electronic shutter (1/60 to 1/10 000 s)
- Compatible with EIA standard
- Package : 16-pin SDIPICERDIP](WDIPO1 6-N-050( ン)



1/3 type B/W CCD Area Sensor for EIA

## BLOCK DIAGRAM



## PIN DESCRIPTION

SYMBOL	PIN NAME
RD	Reset transistor drain
OD	Output transistor drain
Os	Video output
φRS	Reset transistor gate clock
$\phi_{\mathrm{V1}},\phi_{\mathrm{V2}},\phi_{\mathrm{V3}},\phi_{\mathrm{V4}}$	Vertical shift register gate clock
фн1, фн2	Horizontal shift register gate clock
OFD	Overflow drain
Pw	P type well
AGND	Analog part ground
CGND	Clock part ground
Т1, т2	Test terminal

# **ABSOLUTE MAXIMUM RATINGS**

		۰ ۱	D = LOO
PARAMETER	SYMBOL	RATING	UNIT
Output transistor drain voltage	Vod	Oto +18	v
Reset transistor drain voltage	Vrd	Oto +18	v
Overflow drain voltage	VOFD	• to +55	v
Test terminal, T1	VT1	Oto +18	v
Test terminal, τ2	VT2	-0.3 to +18	v
Reset gate clock voltage	V ¢ RS	-0.3 to +18	v
Vertical shift register clock voltage	V ¢ ∨	-9.0 to +18	v
Horizontal shift register clock voltage	Vøн	-0.3 to +18	v
Voltage difference between PW and vertical clock	Vpw – Vøv	-27 to O	v
Storage temperature	Tstg	-20 to +80	°C
Operating ambient, temperature	Topr	$-20 t_{0} + 70$	°C.

 $(Ta = 25^{\circ}C)$ 

## **RECOMMENDED OPERATING CONDITIONS**

PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNIT	NOTE	
Operating ambient temperature		Topr		25,0		°C		
Output trans	istor drain vo	oltage	Vod	14.5	15.0	16.0	v	
Reset transis	stor drain vol	tage	Vrd		Vod		v	
Overflow	When DC is	s applied	Vofd	5.0		19.0	v	1
drain	When pulse p-p level	e is applied	V ¢ OFD	22.0			v	2
Analog part	ground		AGND		0.0		v	
Clock part g	Clock part ground		CGND		0.0		v	
P-well voltage		VPW	-9.0		Vøv∟	v		
Test terminal, Tı		<b>V</b> T1		Vod		v		
Test termina	Test terminal, T2		VT2		0,0		v	
Vertical shift register clock		LOW level	V φ V1L, V φ V2L V φ V3L, V φ V4L	- 8.5	-8.0	-7,5	v	
	INTERMEDIATE level	V & V11, V & V21 V & V31, V & V41		0,0		v		
		HIGH level	Vøv1h, Vøv3h	16.0	16.5	17.0	v	
Horizontal shift		LOW level	VøH1L, VøH2L	-0.05	0.0	0.05	v	
register clock	HIGH level	Vøh1h, Vøh2h	4,7	5.0	6.0	v		
Decet rate	aliali	LOW level	ν φ RSL	0,0		Vrd - 12.0	v	
Reset gate clink	CIIIK	HIGH level	V ¢ RSH	VRD-7.5		9.5	v	
Vertical shift register clock frequency		føv1, føv2 føv3, føv4		15.73		kHz		
Horizontal shift register clock frequency		føhi, føh2		9.53		MHz		
Reset gate	Reset gate clock frequency		føRS		9.53		MHz	

NOTES :

1. When DC voltage is applied, shutter speed is 1 /60 seconds.

2. When pulse is applied, shutter spaed is less than 1/60 seconds.

## ELECTRICAL CHARACTERISTICS (Drive method : Field Accumulation)

(Ta=  $25^{\circ}$ C, Operating conditions : typical values for the recommended operating conditions, Color temperature of light source : 3200 K / IR cut-off filter (CM-500, 1 mmt))

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	NOTE
Photo response non-uniformity	PRNU			10	%	2
Saturation signal	Vsat	500			mV	3
Dark output voltage	Vdark		0.3	3.0	mV	1, 4
Dark signal non-uniformity	DSNU		0.6	2.0	mV	1, 5
Sensitivity	R	240	360		mV	6
Gamma	Y		1			
Smear ratio	SMR		0.009	0,016	%	7
Image lag	AI			1.0	%	8
Blooming suppression ratio	ABL	1000				9
Output transistor drain current	lod		4.0	6.0	mA	
Output impedance	Ro		300		Ω	
Dark noise	Vnoise		0,2	0.4	mV	10
OB difference in level				1,0	mV	11

- The standard output voltage is defined as 150 mV by the average output voltage under uniform illumination.
- The standard exposure level is defined when the average output voltage is 150 mV under uniform illumination.

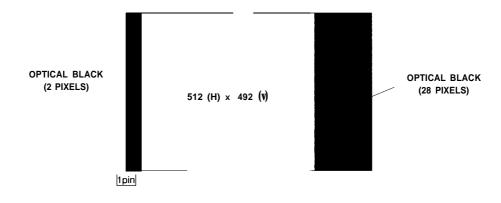
#### NOTES :

- 1. Ta : +60°C
- 2. The image area is divided into 10X 10 segments. The segment's voltage is the average output voltage of all the pixels within the segment. PRNU is defined by (Vmax Vmin)/Vo, where Vmax and Vmin are the maximum and the minimum values of each segment's voltage respectively, when the average output voltage Vo is 150 mV.
- 3 The image area is divided into 10X 10 segments. The saturation signal is defined as the minimum of each segment's voltage which is the average output voltage of allthe pixels within the segment, when the exposure level is set as 10 times, compared to standard level.
- 4 The average output voltage under a non-exposure condition.
- 5 The image area is divided into 10X 10 segments. DSNU is defined by (Vdmax – Vdmin) under the non-exposure condition where Vdmax and Vdmin are the maximum and the minimum values of each segment's voltage, respectively,

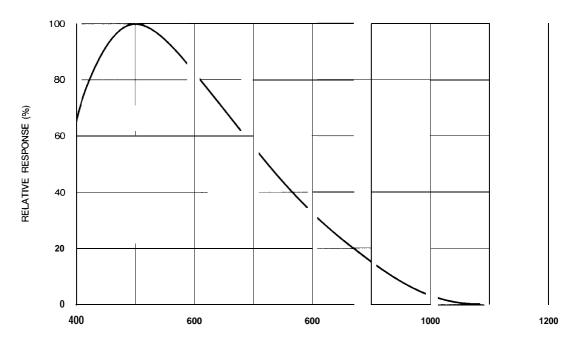
that is the average output voltage over all pixels in the segment.

- The average output voltage when a 1 000 lux light source attached with a 90% reflector is imaged by a lens of F4, f50 mm.
- 7. The sensor is adjusted to position a V/I O square at the center of image area where V is the vertical length of the image area. SMR is defined by the ratio of the output voltage detected during the vertical blanking period to the maximum of the pixel voltage in the V/I O square.
- 8. The sensor is exposed at the exposure level corresoonding to the standard condition preceding non-exposure condition. Al is defined by the ratio between the output voltage measured at the 1st field during the non-exposure period and the standard output voltage.
- 9 The sensor is adjusted to position a V/I O square at the center of image area. ABL is the ratio between the exposure at the standard condition and the exposure at a point where a blooming is observed.
- 10 The RMS value of the dark noise (after CDS). The bandwidth range is from 1 00 kHz to 4.2 MHz.
- 11 The difference between the average output voltage of the effective area and the OB part under the non-exposure condition.

# PIXEL STRUCTURE



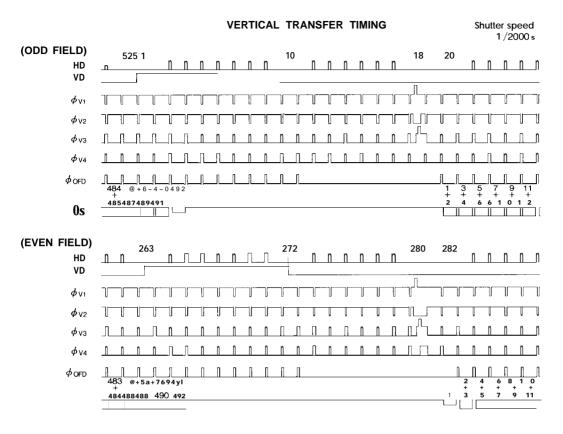
## SPECTRAL RESPONSE EXAMPLE



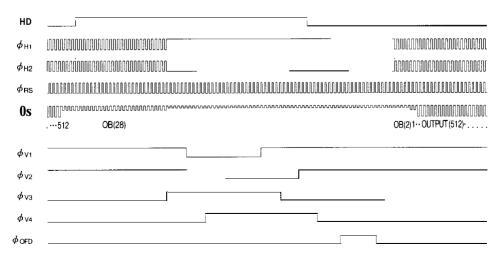
WAVE LENGTH (rim)

## SHARP

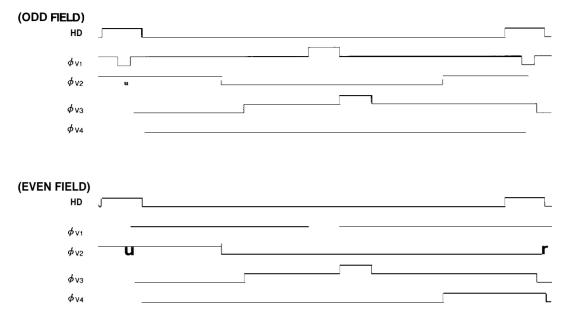
## TIMING DIAGRAM EXAMPLE



#### HORIZONTAL TRANSFER TIMING



## READOUT TIMING



# SYSTEM CONFIGURATION EXAMPLE

